

**CLAIM AMENDMENTS:**

Claim 1 (Currently Amended): An LED backlight module, comprising:  
a printed circuit board;  
a plurality of LEDs disposed on the printed circuit board, and being  
arranged on the printed circuit board in a matrix; and  
a light transmissive material coating on the printed circuit board, wherein  
the LEDs are embedded in the light transmissive material.

8  
Claim 2 (Currently Amended): The LED backlight module as claimed in  
claim 1, wherein the LEDs are arranged on the printed circuit board in a matrix.

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2  
Claim 3 (Original): The LED backlight module as claimed in claim 1,  
wherein the LEDs are disposed on the printed circuit board by means of Surface  
Mount Technology (SMT).

3  
Claim 4 (Original): The LED backlight module as claimed in claim 1,  
wherein the printed circuit board has a reflective material disposed thereon to  
reflect light.

7  
Claim 5 (Currently Amended): ~~The~~ An LED backlight module, comprising:  
~~as claimed in claim 1 further comprising~~  
a printed circuit board;

a plurality of LEDs disposed on the printed circuit board;  
a light transmissive material coating on the printed circuit board, wherein  
the LEDs are embedded in the light transmissive material; and  
a plurality of spacers implanted in the light transmissive material.

**4**  
Claim **4** (Currently Amended): The LED backlight module as claimed in claim 1, further comprising a plurality of spacers implanted on the surface of the light transmissive material.

**5**  
Claim **5** (New): The LED backlight module as claimed in claim 1, wherein the LEDs are connected directly to the printed circuit board.

**9** **7**  
Claim **9** (New): The LED backlight module as claimed in claim **7**, wherein the LEDs are connected directly to the printed circuit board.

**6**  
Claim **6** (New): The LED backlight module as claimed in claim 1, further comprising a plurality of spacers implanted in the light transmissive material.